PCN Number:	20190820010	1	PCN Date:	Sep	t. 13, 2	019	
Title: Datasheet for CDCUN1208LP							
Customer Con	tact: PCN Manager			De	pt:	Quality Services	
Change Type:					-	- County Control	
Assembly S	Site	Design			Wafer	Bump Site	
Assembly Process						Bump Material	
Assembly Materials			Part number change			Bump Process	
Mechanical Specification		Test Site				Fab Site	
	ipping/Labeling	Test Proc	255			Fab Materials	
	.ppg/ _a.s sg	,,		一百		Fab Process	
Notification Details							
Description of		<u> </u>	on Details				
	nts Incorporated is ann	nouncing ar	information or	ılv no	ntificatio	n	
	asheet(s) is being upd	_		•	Julicatio)II.	
	nange history provides			•			
The following ci	larige motory provides	rareirer act	ans.				
L ia Texas							
INSTRUM	ENTS					CDCUN1208LP	
	21110			SC	AS928D - MA	Y 2012-REVISED APRIL 2019	
Changes from De	vision C (March 2017) to Revi	icion D				Dawa	
Changes from Rev	vision C (March 2017) to Revi	ISION D				Page	
 Changed applic 	ations list					1	
 Added type des 	Added type descriptions to the Pin Functions table				4		
 Changed input 	voltage maximum from: VDDx	+ 0.5 to: V _{DD} +	0.5 in the Absolute M	1aximu	m Ratings	table 6	
 Added the junct 	tion temperature range to the A	bsolute Maxim	um Ratings table			6	
Changed the output current unit from mA °C to mA and moved the °C unit to the storage temperature parameter in							
	the Absolute Maximum Ratings table 6						
	Added note on V _{DD} and V _{DDOx} supply voltages						
Added text "Pull ADDR to GND for I2C communication" to the CDCUN1208LP Host Configuration Pins table							
Changed SPI Message Format graphic to correct SCS timing.							
Changed CDCUN1208LP Device Addressing - SPI Mode graphic to correct SCS timing.							
Changed SPI Timing Diagram graphic to correct SDI. Changed to in SPI Timing Specifications table to "SDI to SCI hold time".							
Changed t ₃ in SPI Timing Specifications table to "SDI to SCL hold time"							
Changed t ₈ in SPI Timing Specifications table to "SCL falling edge to SCS release time"							
Changed I ² C address to 7b'0101000 in CDCUN1208LP I ² C Message - Addressing graphic							
Changed description to reflect that the I ² C address is 7b'0101000 in CDCUN1208LP Device Addressing (I ² C Address) section							
Added content to the Application Information section							
Added content to the Apphiculant Information section							
The datasheet r	number will be changin	a					
Device Family	idiliber will be changin	Change	From		Change	- To:	
CDCUN1208LP		SCAS92	28C		SCAS9	28D	
These changes may be reviewed at the datasheet links provided.							
http://www.ti.com/product/CDCUN1208LP							
Reason for Ch	ange:						
To accurately reflect device characteristics.							
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):							
No anticipated impact. This is a specification change announcement only. There are no changes							
to the actual de		cation that	ige aimouncem	CIIC U	niny. III	cic are no changes	
Changes to product identification resulting from this PCN:							
None.							
None.							

Product Affected:					
CDCUN1208LPRHBR	CDCUN1208LPRHBT				

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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